

U.S. Patent Documents

Examiner Initials	Document No.	Date	Name	Class Subclass	Filing Date If Approp.
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Document No.	Date	Country	Class Subclass	Translation Yes No
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"Suppression Shield for RF Plasma", W. J. Curry et al, IBM Technical Disclosure Bulletin, Vol. 22, No. 11, April 1980, pp 4909-4910

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\*Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.